Trek Model 646

Electrostatic Chuck Supply



Trek's Model 646 software-driven Electrostatic Chuck Supply offers an array of features that provide significant benefits while accommodating a variety of demanding applications. Model 646 incorporates Trek technology which has demonstrated increases in efficiency and throughput equal to three times that of other supplies. Virtual elimination of sticky wafer and wafer popping issues ensures better control over particle contamination.

Given the versatility and performance of the Model 646, it can be used in multiple unique tools/processes, thus eliminating the need to specify a new supply for each unique tool/process in a facility.

Key Specifications

- Output Phasing: Voltage A (Reference Phase) Voltage B (Phase B = [-1] x Phase A)
- Output Voltage Range:
- Output Current Range:

0 to ±3 kV 0 to ±6.5 mADC with a peak capability of 10 mA

0 to ±3 kV

0 to ±3 kV

Typical Applications Include

- Electrostatic-driven handling of materials
- Semiconductor wafer processing
- Non-mechanical transfer of flat panels or other processing materials sensitive to mechanical handling

Features and Benefits

- Supports both Coulombic and Johnsen-Rahbek ESC technologies
- User configurable for custom clamp and declamp sequences and wave shapes
- Electrostatic chuck profiles can be uploaded to the unit and stored internally via a user-friendly software interface
- Reduces backside gas errors, increases throughput, and eliminates sticky/popping wafer issues
- Lockable front panel control interface
- Ability to control parameters such as over-current, wafer-present and wafer-clamped thresholds, clamp voltage, offset voltage and internal or external amplitude/offset control
- Wafer detection includes no wafer, wafer present or wafer clamped status
- Includes in-process-adjustable amplitude/offset and output-control versatility
- Output can be controlled by back panel I/O, serial computer command or front panel controls
- NIST-traceable Certificate of Calibration provided with each unit



Model 646 Specifications		Features	
Outputs		Clamped Wafer	To indicate wafer clamping events, the
Simultaneous High- Voltage Outputs	Two simultaneous high-voltage outputs (Output Phase A and Output Phase B) of equal magnitude and opposite in polarity relative to an offset voltage	(Thresholds are set by the program)	sine wave, super-imposed on the Phase A and Phase B outputs, are monitored but can be disabled through the program. The super- imposed waveform is used to indicate a no wafer, wafer present or wafer clamped status
Output Phasing		Capacitive Load	Clamped capacitance status range can be
Output Voltage A (Reference Phase)	0 to ±3 kV	Select	selected by the program for 0 to 10, 20 or 30nF (phase to phase) depending on the system and electrostatic clamp physical configurations
Output Voltage B	0 to ±3 kV (Phase B =[-1] x Phase A)	Mechanical	
Offset Voltage (This feature can be disabled through the program)	Each DC output voltage (Phase A and Phase B) is ramped up and down with symmetrical rise and fall times, or they can be programmed with the user's custom clamping and declamping waveforms. The clamping process is initiated in response to the Clamp On/Off control. The polarity of each output reverses to the opposite polarity after each Clamp On/Off cvcle.	Dimensions	88.1 mm H x 431.8 mm W x 531.9 mm D (3.47" H x 17" W x 20.9" D) 1U rack enclosure
		Panel Width	482.6 mm (19")
		Weight	11 lbs (5.0 kg)
Output Waveshape	Each DC output voltage (Phase A and Phase B) is ramped up and down with symmetrical rise and fall times, or can be programmed with the user's custom clamping and declamping	Connectors	15-pin "D" ITT Canon used by remote device to control/monitor the unit, 9-pin "D" ITT Canon RS- 232, 3-Pin FCT "D" High-Voltage, standard type-A USB, Ethernet (optional) and Front Panel
	waveforms	Power ON/OFF	2-position rocker switch
Output Voltage Range	0 to ±3 kV DC, maximum	Operating Condi	itions
Output Current	0 to ± 6.5 mA DC with peak capability of 10 mA	Temperature	0°C to 35°C (32°F to 104°F)
Input		Relative Humidity	To 85%, noncondensing
Setting the High-	HV magnitude can be controlled either	Altitude	To 2000 meters (6561.68 ft.)
Voltage Amplitude	externally or internally to the unit	Electrical	
Setting the Offset Voltage	Offset voltage may be controlled externally or internally to the unit	DC Input Receptacle	2.0 mm locking DC jack; center contact is positive and shell is negative (receptacle mates with Switchcraft S761K plug)
Output Voltage Monitor (Back Panel Connector)			
Scale Factor	1 V/300 V	Ground Receptacle	
Phase B DC	Accuracy better than 0.5% of full scale	Power Requirements	24 V DC, 2.0 A
Offset Voltage	Less than 10 mV	Supplied Access	sories
Output Noise	Less than 50 mV rms*	Operator Manual, SW	PN: 24013
Steady State Voltage Leakage Current Monitor		USB Cable HV Connector	PN: BA103 PN: B8076R
Scale Factor	1 V / 1 µA	DC Plug (Switchcraft	PN: BA119R
DC Accuracy	±0.1 µA	S761K)	
Output Noise	Less than 50 mV rms*	Line Cord, Fuses	Selected per geographic destination
Features		Optional Access	sories
Interlock	Connections are provided to support an interlock safety configuration. In the event that the interlock is open, the high-voltage generation circuits are shut down	90-264 V AC to 24 V DC Power Adapter	PN: IK045
Digital Display	- 40X2 I CD character display shows various		
	system functions such as Set Voltage, Output Voltage and Capacitance Monitor	Irek Model 645, a ±2 k available. Please conta	v model version of the instrument, is also act the factory for more information

*Measured using the true rms feature of the HPModel 34401A digital multimeter



Copyright © 2012 TREK, INC. All specifications are subject to change. 1305/JRB



Measurement and Power Solutions[™]